LTEL SG-TC3.0

Thermally Conductive Gap Filler Pad

Thermal Conductivity: 3.0 W/m-K

SILTEL SG-TC3.0 is an electrically insulating thermally conductive silicone gap filler material ideal for use in applications where thermal transfer over large gaps (large tolerances) or different stack ups must be achieved. Due to the specific formulation and ceramic particle filler, SG-TC3.0 demonstrates high thermal conductivity through it's compliable feature and overall elastomer design.

Through SG-TC3.0's softness, the pad perfectly mates to irregular surfaces thus filling gaps and operates at low pressure offering low thermal resistance. The natural tackiness of the material allows for an easy and reliable pre-assembly.

SILTEL SG-TC3.0 is available in sheets or TIMTEL cut parts to match a wide range of industry standard or customer defined outlines.

- Soft and Compliable Pad Design
- High Thermal Conductivity Gap Filler
- Excellent Chemical Resistance and Stability
- Operates at Low Pressure
- Shock Absorbing

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Tacky Both Sides (Optional tack one side)

Standard SILTEL SG-TC3.0 Cross Section

Standard is Tacky Both Sides

SG-TC3.0 Pad

ceramic filled silicone pad only (no substrate)

- **Typical Applications**
- SMD Packages
- Through-hole Vias
- **RDRAMs Memory Modules**
- Electronics to Heat Pipe Assemblies
- **Standard Thickness Options**

SG.50-TC3.0	0.020" (0.50mm)
SG1.0-TC3.0	0.039" (1.00mm)
SG2.0-TC3.0	0.078" (2.00mm)
SG3.0-TC3.0	0.118" (3.00mm)

Additional 0.158" (4mm) and 0.197" (5mm) thicknesses available

SG-TC3.0 General Properties

Thermal Conductivity	3.0 W/m-K
Color:	Light Blue
Hardness	55 (Shore 00)
Dielectric Strength	
Volume Resistivity	1.0 x 10 ¹¹
Operating Temperature	60°C to 180°C

0.020" / 0.50mm Thermal Resistance

Thermal Impedance @ 10 PSI0.260 °C in ² / Watt
Thermal Impedance @ 30 PSI0.240 $^{o}\text{C}\ \text{in}^2$ / Watt
Thermal Impedance @ 60 PSI0.220 °C in ² / Watt

0.039" / 1.00mm Thermal Resistance

Thermal Impedance @ 10 PSI0.480 $^{\rm o}{\rm C~in}^2$ / Watt
Thermal Impedance @ 30 PSI0.440 $^{o}\text{C}\ \text{in}^2$ / Watt
Thermal Impedance @ 60 PSI0.400 °C in² / Watt

0.078" / 2.00mm Thermal Resistance

Thermal Impedance @ 10 PSI......0.880 °C in² / Watt Thermal Impedance @ 30 PSI.....0.770 °C in2 / Watt Thermal Impedance @ 60 PSI.....0.680 °C in² / Watt

0.118" / 3.00mm Thermal Resistance

Thermal Impedance @ 10 PSI1.250 $^{\circ}\text{C}\ \text{in}^2$ / Watt
Thermal Impedance @ 30 PSI1.090 $^{\circ}\text{C}$ in 2 / Watt
Thermal Impedance @ 60 PSI0.950 °C in ² / Watt

Characteristic	SILTEL SG-TC3.0
Base Material	Ceramic Filled Silicone
Substrate	NONE
Color	Light Blue
Available Formats	Sheets or Cut Pads
Standard Sheet Sizes (0.5mm / 1mm)	18.90" x 18.11" (480mm x 460mm)
Standard Sheet Sizes (2mm)	18.11" x 18.11" (460mm x 460mm)
Standard Sheet Sizes (3mm / 4mm)	18.11" x 17.71" (460mm x 450mm)
Standard Sheet Sizes (5mm)	17.71" x 17.71" (450mm x 450mm)
TIMTEL Cutting Capabilities	Razor Plotter Cut for Gap Filler Pads
TIMTEL Die Cut Delivery Formats	Individuals or Multiples per Master Sheet
TIMTEL Die Cut Dimensional Tolerances	0.010"(0.25mm) to 0.020"(0.51mm) (depending on thickness
Storage	Cool, dry location at or below 80F/ 27C
Shelf Life	2 years from date of manufacture

Thermal material evaluation is always critical when designing in a new material or developing a new product. These sheet samples of SILTEL are intended to determine the optimal SILTEL thickness as well as overall material construction and performance best suited within the scope of your application requirements.

Please contact us for more information on how to order specific sizes and shapes for your final design requirements.



Supplied By:



Capacitors

- Interfaces with Large Gaps / Tolerances